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## Dr. Kitty Pearsall

IEEE Electronic Packaging Society President

**Kitty Pearsall** received the BS degree in Metallurgical Engineering and her MS and PhD degrees in Mechanical Engineering and Materials from the University of Texas. Across my 41-year career at IBM, I was appointed to strategic roles while implementing global cross commodity processes/products.

- Retired, IBM Distinguished Engineer in Integrated Supply Chain since 2000 2013
- Emeritus Member of the IBM Academy of Technology (2005)
- IBM Women in Technology Fran E. Allan Mentoring Award (2006)
- UT Mechanical Engineering Dept. Academy of Distinguished Alumni (2007)
- UT Austin Cockrell Engineering Distinguished Engineering Graduate Award (2008)
- IEEE EPS David Feldman Outstanding Contributor Award (2020)
- IEEE Electronic Packaging Society President (2022 2023)
- Numerous internal IBM publications as well as 22 external publications
- Awarded 13 US Patents and 8 published IP disclosures
- Many IBM Outstanding Technical Achievement Awards

Currently Kitty is President of Boss Precision Inc. and works as an independent consultant. Kitty has been an active member of IEEE for 33 years as well as an EPS member for 28 years, with growing roles and responsibilities, including ECTC Manufacturing Technology Committee, ECTC PDC Chair since 2006 and EPS/CPMT Board of Governors since 2005. Received the EPS David Feldman Award in 2020.